SPEC. NO.: PS-53014-002XX-XXX **REVISION:** C

PRODUCT NAME: I/O STANDARD BATTERY HOLDER SMT 2P

PRODUCT NO: 53014-002XX-XXX / 53011-002XX-XXX / 54983-002XX-XXX
54986-002XX-XXX

APPROVED:	CHECK:	PREPARED:
Liang,lin ji	Lu,jing quan	Hsieh,fu yu
DATE: 2017/10/23	DATE: 2017/10/23	DATE: 2017/10/23

1 Revision History

Rev.	ECN #	Revision Description	Prepared	Date
1	ECN-1112561	PROPOSAL	WENDE	2011/12/30
O	ECN-1211237	RELEASE	XIAOXIONG	2012/11/27
A	ECN-1401271	ADD Working Voltage	LIUJINLAN	2014/01/18
B	ECN-1706304	ADD 54983 series and Terminal retention force	XIAOXIONG	2017/04/14
C	ECN-1710290	ADD 54986 series	Liang,lin ji	2017/10/23

2 SCOPE

This specification covers performance, tests and quality requirements for I/o standard battery holder smt type.

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

4.1 Design and Construction

4.1.1 Connector shall be of the design, construction and physical dimensions specified on the applicable sales drawing.
4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.

4.2 Materials and Finish

4.2.1 Contact: High performance copper alloy
Finish: Pls. refer to the drawing.
4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0

4.3 Ratings

4.3.1 Working Voltage Less than 36 Volts AC (per pin)
4.3.2 Voltage: 250 V AC (per pin)
4.3.3 Current: 3.0 Amperes (per pin)
4.3.4 Operating Temperature : -40℃ to +85℃

5 Performance

5.1. Test Requirements and Procedures Summary

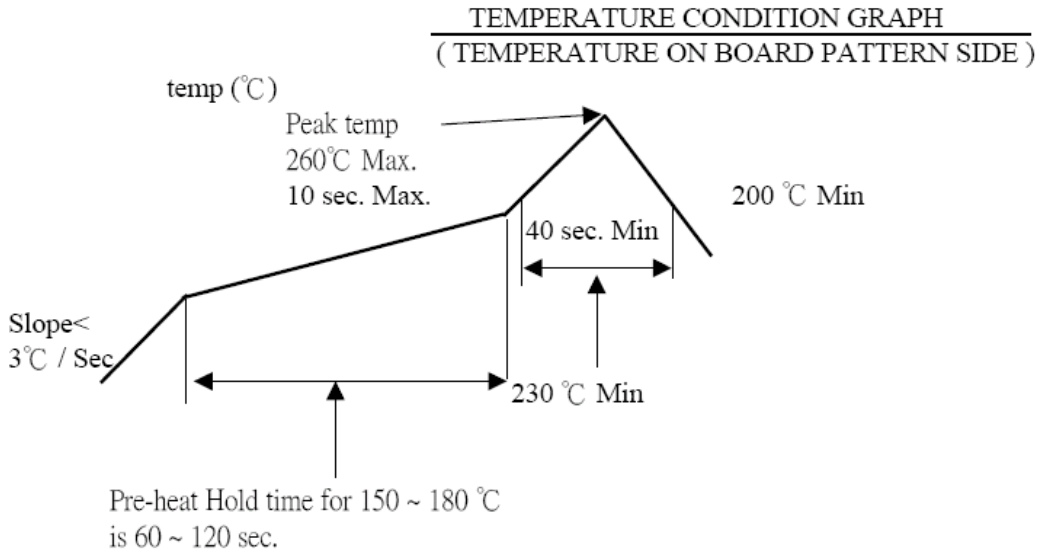
Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.
ELECTRICAL		
Item	**Requirement**	**Standard**
Low Level Contact Resistance	50 m Ω Max.(initial)per contact △R 50 m Ω Max.	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	1000 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	1000 V AC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature Rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25℃ (EIA-364-70 METHOD 1,CONDITION 1)
MECHANICAL		
Item	**Requirement**	**Standard**
Durability	20 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min.
Terminal /Housing Retention Force	0.8kgf MIN.	Operation Speed： 25.4 ± 3 mm/minute. Measure the contact retention force with tester.

Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50G's(peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 10mA maximum for all contacts. (EIA-364-27, test Condition A)
ENVIRONMENTAL		
Item	**Requirement**	**Standard**
Resistance to **Reflow** Soldering Heat	See Product Qualification and Test Sequence Group 10 **(Lead Free)**	Pre Heat：150℃~180℃, 60~120sec. Heat：230℃ Min., 40sec Min. Peak Temp.：260℃Max, 10sec Max.
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 ℃, 30 minutes +85 +3/-0 ℃, 30 minutes (EIA-364-32, test condition I)
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40℃, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)
Temperature Life	See product Qualification and test sequence group 5	Subject mated connectors to temperature life at 85℃ for 96 hours. (EIA-364-17, Test condition A)

Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35℃ (I) Gold flash for 8 hours (II) Gold plating 5 u" for 96 hours. (EIA-364-26)
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5℃, for 4-5 sec. (EIA-364-52)
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350℃, 3sec at least.

Note. Flowing Mixed Gas shell be conduct by customer request.

6 INFRARED REFLOW CONDITION



7 PRODUCT QUALIFICATION AND TEST SEQUENCE

Test or Examination	Test Group										
	1	2	3	4	5	6	7	8	9	10	
	Test Sequence										
Examination of Product	1,3			1,7	1,6	1,4		1,4			
Low Level Contact Resistance		1,3	1,4	2,10	2,9	2,5		2,5			
Insulation Resistance				3,9	3,8						
Dielectric Withstanding Voltage				4,8	4,7						
Temperature Rise	2										
Durability		2									
Terminal / Housing Retention Force										1	
Vibration			2								
Shock(Mechanical)			3								
Resistance to Soldering Heat								3			
Thermal Shock				5							
Humidity				6							
Temperature Life					5						
Salt Spray(Only For Gold Plating)						3					
Solder ability							1				
Hand Soldering Temperature Resistance									1		
Sample Size	2	4	4	4	4	4	4	4	4	4	